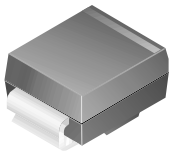
FAIRCHILD
SEMICONDUCTOR®

ES2A - ES2D

Features

- For surface mount applications.
- Glass passivated junction.
- Low profile package.
- Easy pick and place.
- Built-in strain relief.
- Superfast recovery times for high efficiency.



SMB/DO-214AA
COLOR BAND DENOTES CATHODE

Fast Rectifiers

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value				Units
		2A	2B	2C	2D	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	150	200	V
$I_{F(AV)}$	Average Rectified Forward Current .375 " lead length @ T_A = 110°C	2.0				A
I_{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	50				A
T_{stg}	Storage Temperature Range	-55 to +150				°C
T_J	Operating Junction Temperature	-55 to +150				°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	1.66	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	75	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	20	°C/W

*Device mounted on FR-4 PCB 0.013 mm.

Electrical Characteristics

T_A = 25°C unless otherwise noted

Symbol	Parameter		Device				Units
			2A	2B	2C	2D	
V_F	Forward Voltage @ 2.0 A		0.90				V
t_{rr}	Reverse Recovery Time I_F = 0.5 A, I_R = 1.0 A, I_{RR} = 0.25 A		20				ns
I_R	Reverse Current @ rated V_R	T_A = 25°C	10				µA
		T_A = 100°C	350				µA
C_T	Total Capacitance V_R = 4.0 V, f = 1.0 MHz		18				pF

Typical Characteristics

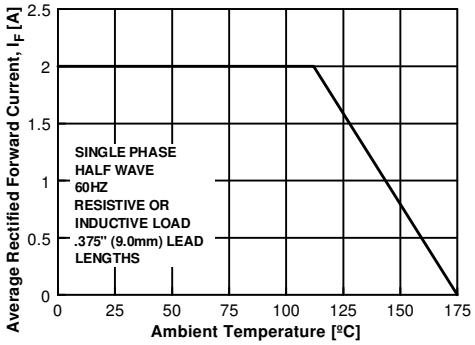


Figure 1. Forward Current Derating Curve

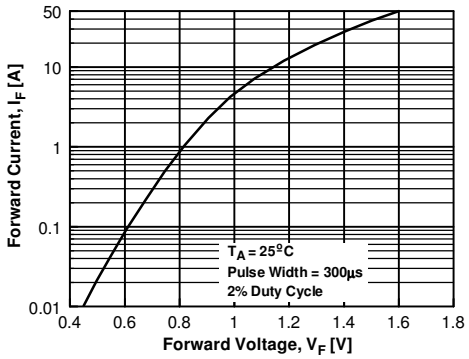


Figure 2. Forward Voltage Characteristics

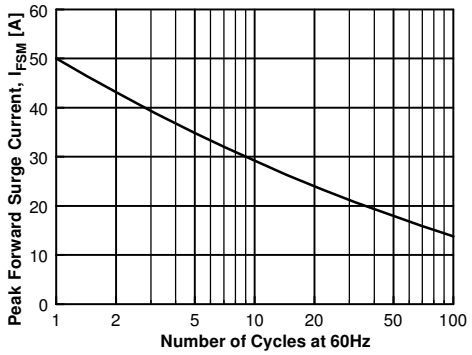


Figure 3. Non-Repetitive Surge Current

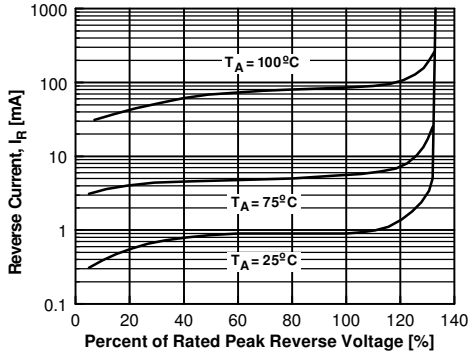


Figure 4. Reverse Current vs Reverse Voltage

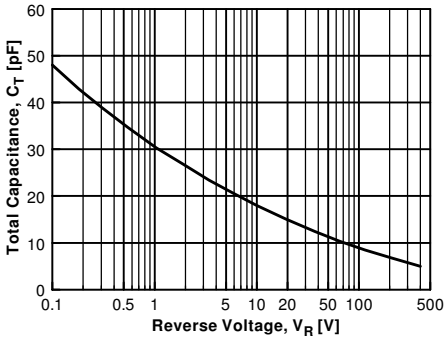
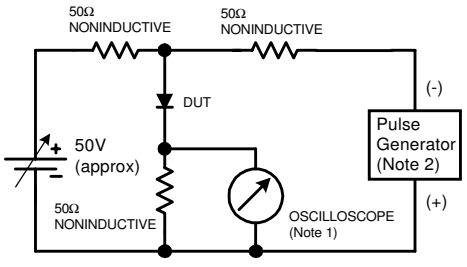
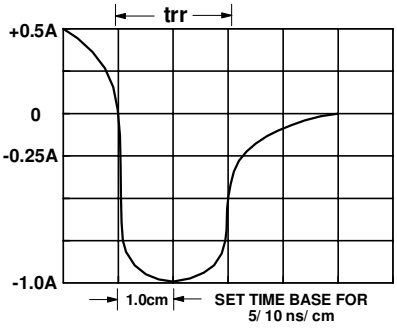


Figure 5. Total Capacitance



NOTES:
1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.
2. Rise time = 10 ns max; Source impedance = 50 ohms.



Reverse Recovery Time Characterstic and Test Circuit Diagram

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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